



DMTH4004LK3

40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C (Note 9)	
40V	$3m\Omega @ V_{GS} = 10V$	100A	
	$5m\Omega @ V_{GS} = 4.5V$	100A	

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

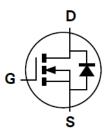
- Engine Management Systems
- Body Control Electronics
- DC-DC Converters

Features

- Rated to 175° C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Rdson Minimizes Power Losses
- Low Qg Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMTH4004LK3Q</u>)

Mechanical Data

- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.33 grams (Approximate)

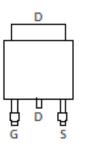


Equivalent Circuit

TO252 (DPAK)



Top View



Pin Out Top View

Ordering Information (Notes 4)

Part Number	Case	Packaging
DMTH4004LK3-13	TO252	2,500/Tape & Reel

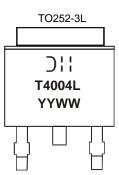
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



JII =Manufacturer's Marking
T4004L = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year
(ex: 15 = 2015)
WW = Week Code (01 to 53)



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage		V _{DSS}	40	V	
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Drain Current (Note 6), $V_{GS} = 10V$	T _C = +25°C (Note 9)	ID	100	А	
	$T_{C} = +100^{\circ}C$		100		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	200	A	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	100	A		
Avalanche Current, L = 0.2mH	I _{AS}	30	A		
Avalanche Energy, L = 0.2mH	E _{AS}	90	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.9	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	38	°C/W	
Total Power Dissipation (Note 6) $T_{C} = +25^{\circ}C$		PD	180	W
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	0.8	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}		_	1	μA	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Proven		2.4	3	mΩ	$V_{GS} = 10V, I_D = 50A$	
	R _{DS(ON)}	_	4	5	mΩ	$V_{GS} = 4.5V, I_D = 50A$	
Diode Forward Voltage	V _{SD}		0.7	1.2	V	$V_{GS} = 0V, I_{S} = 50A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		4,450	_	pF		
Output Capacitance	Coss	_	1,407	—	pF	− V _{DS} = 25V, V _{GS} = 0V, − f = 1MHz	
Reverse Transfer Capacitance	Crss		74	_	pF		
Gate Resistance	Rg		0.7	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg		35	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	-	83	—	nC	Vps = 20V. lp = 30A	
Gate-Source Charge	Q _{gs}	_	10	-	nC	$v_{DS} = 20v, I_D = 30A$	
Gate-Drain Charge	Q _{gd}	—	11.2	_	nC		
Turn-On Delay Time	t _{D(ON)}	—	5.9	_	ns	$V_{GS} = 10V, V_{DS} = 20V,$ $R_g = 1.6\Omega, I_D = 30A$	
Turn-On Rise Time	tr	—	13.2	_	ns		
Turn-Off Delay Time	t _{D(OFF)}	—	25.8	_	ns		
Turn-Off Fall Time	tF		7.9	_	ns		
Body Diode Reverse Recovery Time	t _{RR}	_	48	_	ns	I _F = 50A, di/dt = 100A/µs	
Body Diode Reverse Recovery Charge	Q _{RR}	—	72	—	nC	I _F = 50A, di/dt = 100A/µs	

Notes: 5. Device mounted with exposed drain pad on 25mm by 25mm 2oz copper on a single- sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady state.

6. Thermal resistance from junction to solder point (on the exposed drain pin).

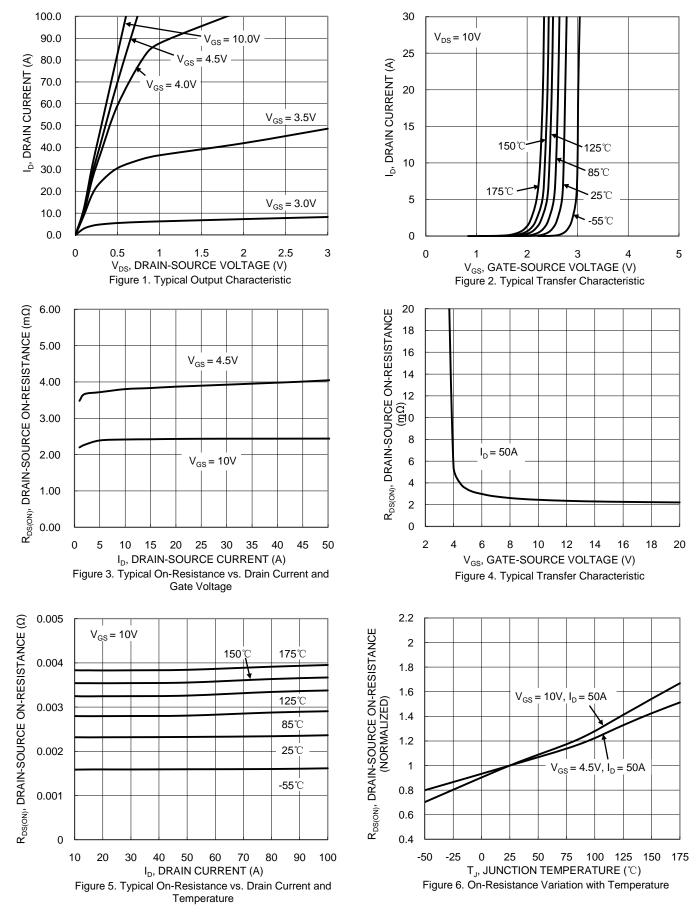
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.

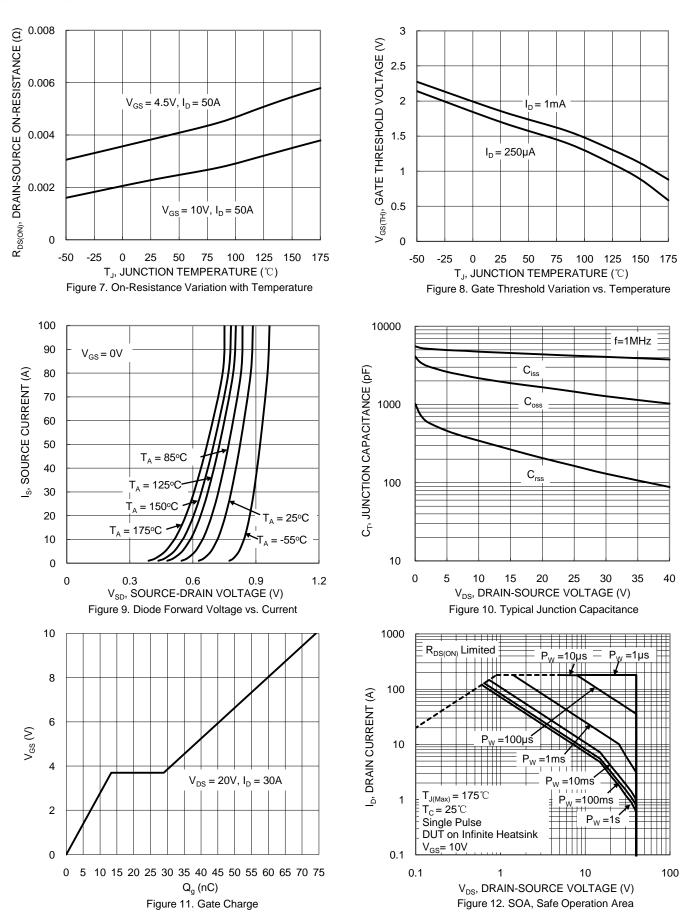
9. Package Limited.



DMTH4004LK3



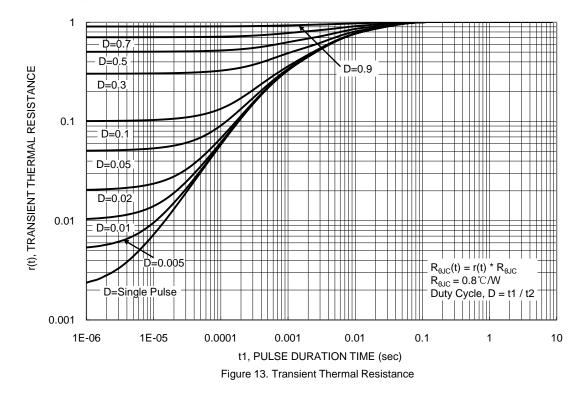




NEW PRODUCT

DMTH4004LK3 Document number: DS37792 Rev. 2 - 2







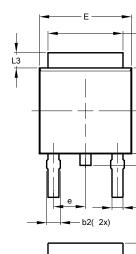
Package Outline

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

b3

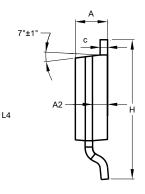
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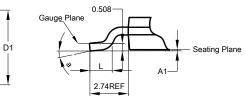
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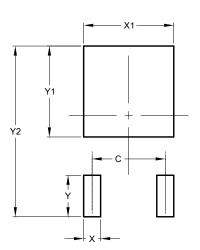




TO252 (DPAK)						
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
c	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	-	-			
е	-	-	2.286			
Е	6.45	6.70	6.58			
E1	4.32	-	-			
Н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



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Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

TO252 (DPAK)

TO252 (DPAK)



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